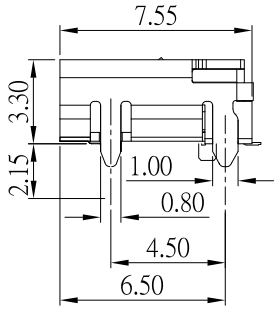
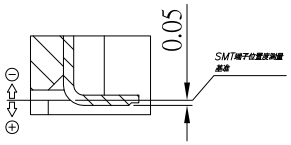
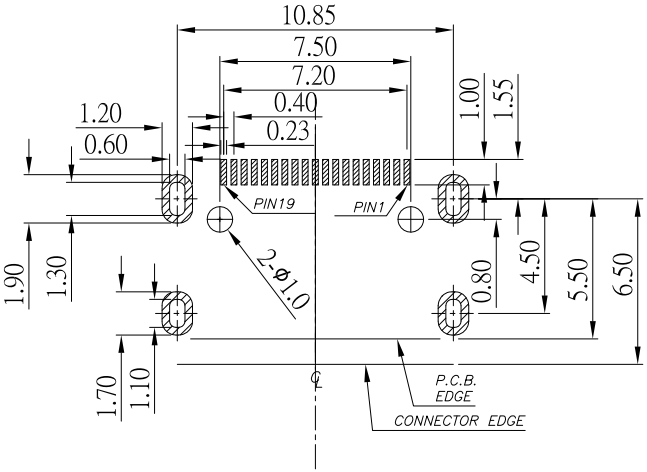
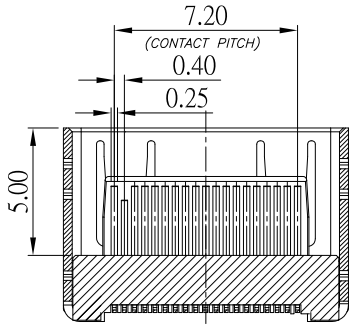




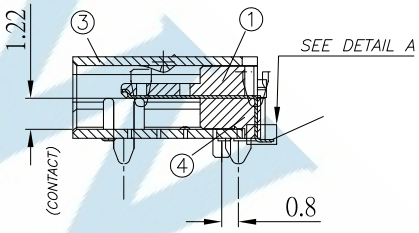
DETAIL A
SCALE 16:1



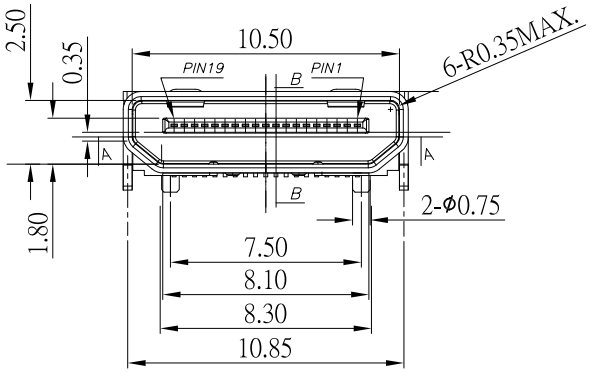
RECOMMENDED PCB LAYOUT(TOP VIEW)

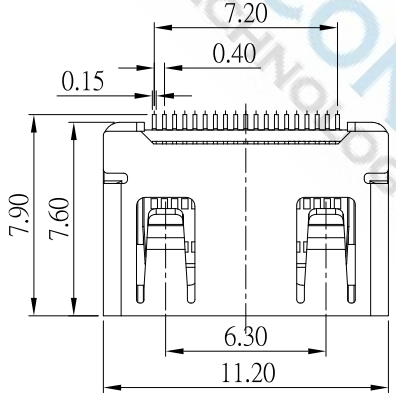


SECTION A–A
SCALE 4:1



SECTION B–B
SCALE 4:1





NOTE:

1.MATERIAL:

1.1 HOUSING: LCP,UL94V-0 , BLACK

1.2 CONTACT: PHOSPHOR BRONZE

1.3 SHEEL: BRASS

2.PLATING :

2.1 CONTACT: PLATED GOLD IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

2.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER
OR GOLD UNDER PLATED SURFACE LAYER

3.MECHANICAL:

3.1 INSERTION FORCE: 4.5 Kgf MAX

3.2 WITHDRAWAL FORCE: 0.71~2.55 Kgf

DIMENSIONS TOLERANCE METRIC .0=±0.30 .00=±0.20 .000=±0.10 ANG.=±2°	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME) HDMI C TYPE SMT TYPE	WISCONN Technology Co.,Ltd	
	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	料號(PART NUMBER) WHDMF-C-19-xxR2	Tel:02-2790-1979 Fax:02-2790-1569	
	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期(DATE)	DEC.30.2015	圖號(DRAW NUMBER) T002	比例(SCALE) 1/1 / 圖紙(SIZE) A4 / 頁次(SHEET) 1 / 版次(REV.) A	
							圖檔(FILE NAME .DWG)		